TDA7577BLV

2 x 75 W dual-bridge power amplifier with I²C complete diagnostics and "start-stop" profile (6 V operation)

Features

- MOSFET (DMOS) output power stage
- High-efficiency (class SB)
- Single-channel 1 Ω driving capability
  - 84 W undistorted power
- High output power capability 2 x 28 W / 4 Ω @ 14.4 V, 1 kHz, 10 % THD
- Max. output power 2 x 75 W / 2 Ω, 1 x 150 W / 1 Ω
- Full I²C bus driving with 4 addresses
- Low voltage (6 V) operation (i.e. 'start-stop')
- Gain 16/26 dB
- Full digital diagnostic (AC and DC loads)
- Legacy mode (operation without I²C)
- Differential inputs
- Fault detection through integrated diagnostics
- DC offset detection
- Two independent short circuit protections
- Diagnostic on clipping detector with selectable threshold (2 % / 10 %)
- Clipping detector pin
- ST-BY and MUTE pins
- ESD protection
- Very robust against misconnections

Description

The TDA7577BLV is a new MOSFET dual bridge amplifier specially intended for car radio applications. Thanks to the DMOS output stage the TDA7577BLV has a very low distortion allowing a clear powerful sound, together with high output power capability.

It is a very flexible device capable to support the most demanding specifications in terms of power dissipation and battery transitions: its superior efficiency performance, coming from the internal exclusive structure, can reduce the dissipated output power up to the 50 % (when compared to conventional class AB solutions). Moreover it is compliant to the recent OEM specifications thanks to the capability to work down to 6 V ('start-stop' compatibility).

This device is also equipped with a full diagnostic array that communicates the status of each speaker through the I²C bus. TDA7577BLV can also drive 1 Ω loads (with parallel connection of the outputs).

It is possible also to exclude the I²C bus interface, controlling the device by means of the usual ST-BY and MUTE pins.

Table 1. Device summary

<table>
<thead>
<tr>
<th>Order code</th>
<th>Package</th>
<th>Packing</th>
</tr>
</thead>
<tbody>
<tr>
<td>TDA7577BLV</td>
<td>Flexi watt 27</td>
<td>Tube</td>
</tr>
<tr>
<td></td>
<td>(vertical)</td>
<td></td>
</tr>
<tr>
<td>TDA7577BLVPD</td>
<td>PowerSO36</td>
<td>Tube</td>
</tr>
<tr>
<td>TDA7577BLVPDTR</td>
<td>PowerSO36</td>
<td>Tape and reel</td>
</tr>
<tr>
<td>TDA7577BLVH</td>
<td>Flexi watt 27</td>
<td>Tube</td>
</tr>
<tr>
<td></td>
<td>(horizontal)</td>
<td></td>
</tr>
<tr>
<td>TDA7577BLVSM</td>
<td>Flexi watt 27</td>
<td>Tube</td>
</tr>
<tr>
<td></td>
<td>(SMD)</td>
<td></td>
</tr>
</tbody>
</table>
Contents

1 Block and pins diagrams .................................................. 6
2 Application circuit ............................................................. 7
3 Electrical specifications ....................................................... 8
  3.1 Absolute maximum ratings .............................................. 8
  3.2 Thermal data ............................................................. 8
  3.3 Electrical characteristics .............................................. 8
  3.4 Electrical characteristics typical curves .......................... 13
4 Diagnostics functional description ....................................... 17
  4.1 Turn-on diagnostic ..................................................... 17
  4.2 Permanent diagnostics ................................................ 19
  4.3 Output DC offset detection .......................................... 20
  4.4 AC diagnostic .......................................................... 20
  4.5 Multiple faults ......................................................... 22
  4.6 Fault presence information availability on I\(^2\)C .................. 22
5 1 Ω load capability setting .................................................. 23
6 Battery transitions management .......................................... 24
  6.1 Low voltage operation ("start stop") .............................. 24
  6.2 Advanced battery management ...................................... 25
7 I\(^2\)C mode and legacy mode selection ................................ 26
8 Application suggestions ..................................................... 27
  8.1 High efficiency introduction ........................................ 27
9 I\(^2\)C bus interface .......................................................... 28
  9.1 Data validity .......................................................... 28
  9.2 Start and stop conditions ............................................. 28
  9.3 Byte format ........................................................... 28
## Contents

9.4  Acknowledge ................................................................. 28  
9.5  I2C programming/reading sequences ................................. 29  

10  Software specifications .................................................. 30  
    10.1  Examples of bytes sequence ...................................... 33  

11  Package information .................................................... 34  
    11.1  PowerSO-36 (slug up) package mechanical data ............ 34  
    11.2  Flexiwatt 27 (vertical) package mechanical data .......... 36  
    11.3  Flexiwatt 27 (horizontal) package mechanical data .... 38  
    11.4  Flexiwatt 27 (SMD) package mechanical data ............. 40  

12  Revision history ........................................................... 42
List of tables

Table 1. Device summary .............................................. 1
Table 2. Absolute maximum ratings ..................................... 8
Table 3. Thermal data .................................................... 8
Table 4. Electrical characteristics ....................................... 8
Table 5. Double fault table for turn on diagnostic ....................... 22
Table 6. Address selection ............................................. 30
Table 7. IB1 ............................................................. 30
Table 8. IB2 ............................................................. 31
Table 9. DB1 ............................................................. 31
Table 10. DB2 ........................................................... 32
Table 11. PowerSO-36 (slug up) package mechanical data ................ 34
Table 12. Flexiwatt 27 (vertical) package mechanical data ............. 36
Table 13. Flexiwatt 27 (horizontal) package mechanical data ............ 38
Table 14. Flexiwatt 27 (SMD) package mechanical data .................. 40
Table 15. Document revision history ..................................... 42
## List of figures

<table>
<thead>
<tr>
<th>Figure</th>
<th>Description</th>
</tr>
</thead>
<tbody>
<tr>
<td>Figure 1.</td>
<td>Block diagram. .............................................. 6</td>
</tr>
<tr>
<td>Figure 2.</td>
<td>Pin connections (top view) .................................. 6</td>
</tr>
<tr>
<td>Figure 3.</td>
<td>Application circuit (TDA7577BLVPD) .......................... 7</td>
</tr>
<tr>
<td>Figure 4.</td>
<td>Quiescent drain current vs. supply voltage .................. 7</td>
</tr>
<tr>
<td>Figure 5.</td>
<td>Output power vs. supply voltage (4 Ω) ....................... 13</td>
</tr>
<tr>
<td>Figure 6.</td>
<td>Output power vs. supply voltage (2 Ω) ....................... 13</td>
</tr>
<tr>
<td>Figure 7.</td>
<td>Output power vs. supply voltage (1 Ω) ....................... 13</td>
</tr>
<tr>
<td>Figure 8.</td>
<td>Distortion vs. output power (4 Ω, STD mode) ............... 13</td>
</tr>
<tr>
<td>Figure 9.</td>
<td>Distortion vs. output power (2 Ω, STD mode) ............... 13</td>
</tr>
<tr>
<td>Figure 10.</td>
<td>Distortion vs. output power (2 Ω, HI-EFF mode). .......... 14</td>
</tr>
<tr>
<td>Figure 11.</td>
<td>Distortion vs. output power (1 Ω, STD mode) ............... 14</td>
</tr>
<tr>
<td>Figure 12.</td>
<td>Distortion vs. frequency (4 Ω load) ......................... 14</td>
</tr>
<tr>
<td>Figure 13.</td>
<td>Distortion vs. frequency (2 Ω load) ......................... 14</td>
</tr>
<tr>
<td>Figure 14.</td>
<td>Distortion vs. frequency (1 Ω load) ......................... 14</td>
</tr>
<tr>
<td>Figure 15.</td>
<td>Output attenuation vs. supply voltage ....................... 14</td>
</tr>
<tr>
<td>Figure 16.</td>
<td>CMRR vs. frequency. ........................................... 15</td>
</tr>
<tr>
<td>Figure 17.</td>
<td>Cross talk vs frequency. ...................................... 15</td>
</tr>
<tr>
<td>Figure 18.</td>
<td>Power dissipation vs. average Po (2 Ω, STD mode, sine wave) 15</td>
</tr>
<tr>
<td>Figure 19.</td>
<td>Power dissipation vs. Po (2 Ω, STD mode, audio program simulation) 15</td>
</tr>
<tr>
<td>Figure 20.</td>
<td>Power dissipation vs. average Po (2 Ω, HI-EFF mode) ....... 15</td>
</tr>
<tr>
<td>Figure 21.</td>
<td>Power dissipation vs. Po (1 Ω, STD mode, audio program simulation) 15</td>
</tr>
<tr>
<td>Figure 22.</td>
<td>ITU R-ARM frequency response, weighting filter for transient pop. 16</td>
</tr>
<tr>
<td>Figure 23.</td>
<td>Turn-on diagnostic: working principle ....................... 17</td>
</tr>
<tr>
<td>Figure 24.</td>
<td>SVR and output behavior - case 1: without turn-on diagnostic 17</td>
</tr>
<tr>
<td>Figure 25.</td>
<td>SVR and output pin behavior - case 2: with turn-on diagnostic 18</td>
</tr>
<tr>
<td>Figure 26.</td>
<td>Short circuit detection thresholds .......................... 18</td>
</tr>
<tr>
<td>Figure 27.</td>
<td>Load detection thresholds - high gain setting .............. 18</td>
</tr>
<tr>
<td>Figure 28.</td>
<td>Load detection thresholds - high gain setting .............. 18</td>
</tr>
<tr>
<td>Figure 29.</td>
<td>Restart timing without diagnostic enable (permanent) each 1ms time, a sampling of the fault is done ......................... 19</td>
</tr>
<tr>
<td>Figure 30.</td>
<td>Restart timing with diagnostic enable (permanent) .......... 19</td>
</tr>
<tr>
<td>Figure 31.</td>
<td>Current detection high: load impedance</td>
</tr>
<tr>
<td>Figure 32.</td>
<td>Current detection low: load impedance</td>
</tr>
<tr>
<td>Figure 33.</td>
<td>Worst case battery cranking curve sample 1 .................. 24</td>
</tr>
<tr>
<td>Figure 34.</td>
<td>Worst case battery cranking curve sample 2 .................. 24</td>
</tr>
<tr>
<td>Figure 35.</td>
<td>Upwards fast battery transitions diagram .................... 25</td>
</tr>
<tr>
<td>Figure 36.</td>
<td>High efficiency - basic structure ........................... 27</td>
</tr>
<tr>
<td>Figure 37.</td>
<td>Data validity on the I2C bus ................................ 28</td>
</tr>
<tr>
<td>Figure 38.</td>
<td>Timing diagram on the I2C bus ................................ 29</td>
</tr>
<tr>
<td>Figure 39.</td>
<td>Timing acknowledge clock pulse ................................ 29</td>
</tr>
<tr>
<td>Figure 40.</td>
<td>PowerSO-36 (slug up) package mechanical drawing .......... 34</td>
</tr>
<tr>
<td>Figure 41.</td>
<td>Flexiwatt 27 (vertical) package mechanical drawing ........ 36</td>
</tr>
<tr>
<td>Figure 42.</td>
<td>Flexiwatt 27 (horizontal) package mechanical drawing ...... 38</td>
</tr>
<tr>
<td>Figure 43.</td>
<td>Flexiwatt 27 (SMD) package mechanical drawing ............. 40</td>
</tr>
</tbody>
</table>
1 Block and pins diagrams

Figure 1. Block diagram

Figure 2. Pin connections (top view)
2 Application circuit

Figure 3. Application circuit (TDA7577BLVPD)
3 Electrical specifications

3.1 Absolute maximum ratings

<table>
<thead>
<tr>
<th>Symbol</th>
<th>Parameter</th>
<th>Value</th>
<th>Unit</th>
</tr>
</thead>
<tbody>
<tr>
<td>V_{op}</td>
<td>Operating supply voltage</td>
<td>18</td>
<td>V</td>
</tr>
<tr>
<td>V_{S}</td>
<td>DC supply voltage</td>
<td>28</td>
<td>V</td>
</tr>
<tr>
<td>V_{peak}</td>
<td>Peak supply voltage (for t = 50 ms)</td>
<td>50</td>
<td>V</td>
</tr>
<tr>
<td>V_{CK, VDATA}</td>
<td>I2C CK and DATA pin voltage</td>
<td>-0.3 to 6</td>
<td>V</td>
</tr>
<tr>
<td>GND_{max}</td>
<td>Ground pin voltage</td>
<td>-0.3 to 0.3</td>
<td>V</td>
</tr>
<tr>
<td>V_{at-by}</td>
<td>Standby pin voltage</td>
<td>-0.3 to V_{op}</td>
<td>V</td>
</tr>
<tr>
<td>V_{CP}</td>
<td>Clip detector voltage</td>
<td>-0.3 to V_{op}</td>
<td>V</td>
</tr>
<tr>
<td>V_{in max}</td>
<td>Input max voltage</td>
<td>-0.3 to V_{op}</td>
<td>V</td>
</tr>
<tr>
<td>I_{O}</td>
<td>Output peak current (not repetitive t = 100 ms)</td>
<td>8</td>
<td>A</td>
</tr>
<tr>
<td>I_{O}</td>
<td>Output peak current (repetitive f &gt; 10 Hz)</td>
<td>6</td>
<td>A</td>
</tr>
<tr>
<td>P_{tot}</td>
<td>Power dissipation (T_{case} = 70 , ^\circ C) (1)</td>
<td>86</td>
<td>W</td>
</tr>
<tr>
<td>T_{slg, Tj}</td>
<td>Storage and junction temperature (2)</td>
<td>-55 to 150</td>
<td>^\circ C</td>
</tr>
<tr>
<td>T_{amb}</td>
<td>Operative temperature range</td>
<td>-40 to 105</td>
<td>^\circ C</td>
</tr>
</tbody>
</table>

1. This is maximum theoretical value; for power dissipation in real application conditions, please refer to curves reported in Section 3.4: Electrical characteristics typical curves.
2. A suitable dissipation system should be used to keep \(T_{j}\) inside the specified limits.

3.2 Thermal data

<table>
<thead>
<tr>
<th>Symbol</th>
<th>Parameter</th>
<th>PowerSO36</th>
<th>Flexiwatt 27</th>
<th>Unit</th>
</tr>
</thead>
<tbody>
<tr>
<td>R_{th j-case}</td>
<td>Thermal resistance junction-to-case</td>
<td>Max</td>
<td>1</td>
<td>1</td>
</tr>
</tbody>
</table>

3.3 Electrical characteristics

Refer to the test circuit, \(V_{S} = 14.4 \, V\); \(R_{L} = 4 \, \Omega\); \(f = 1 \, kHz\); \(G_{V} = 26 \, dB\); \(T_{amb} = 25 \, ^\circ C\); unless otherwise specified.
Tested at \(T_{amb} = 25 \, ^\circ C\) and \(T_{hot} = 105 \, ^\circ C\); functionality guaranteed for \(T_{j} = -40 \, ^\circ C\) to 150 \, ^\circ C.

<table>
<thead>
<tr>
<th>Symbol</th>
<th>Parameter</th>
<th>Test condition</th>
<th>Min.</th>
<th>Typ.</th>
<th>Max.</th>
<th>Unit</th>
</tr>
</thead>
<tbody>
<tr>
<td>V_{S}</td>
<td>Supply voltage range</td>
<td>-</td>
<td>6</td>
<td>-</td>
<td>18</td>
<td>V</td>
</tr>
<tr>
<td></td>
<td>(R_{L} = 2 , \Omega)</td>
<td>6</td>
<td>-</td>
<td>16</td>
<td>V</td>
<td></td>
</tr>
</tbody>
</table>

8/43 DocID025375 Rev 5
### Electrical specifications

#### Table 4. Electrical characteristics (continued)

<table>
<thead>
<tr>
<th>Symbol</th>
<th>Parameter</th>
<th>Test condition</th>
<th>Min.</th>
<th>Typ.</th>
<th>Max.</th>
<th>Unit</th>
</tr>
</thead>
<tbody>
<tr>
<td>( I_d )</td>
<td>Total quiescent drain current</td>
<td>-</td>
<td>-</td>
<td>140</td>
<td>200</td>
<td>mA</td>
</tr>
<tr>
<td>( R_{IN} )</td>
<td>Input impedance</td>
<td>-</td>
<td>-</td>
<td>100</td>
<td>115</td>
<td>140</td>
</tr>
<tr>
<td>( V_{AM} )</td>
<td>Min supply mute threshold</td>
<td>Start-stop IB1(D7) = 0 (default)</td>
<td>5</td>
<td>-</td>
<td>6</td>
<td>V</td>
</tr>
<tr>
<td></td>
<td></td>
<td>No start-stop IB1(D7) = 1</td>
<td>7</td>
<td>-</td>
<td>8</td>
<td>V</td>
</tr>
<tr>
<td>( V_{OS} )</td>
<td>Offset voltage</td>
<td>Mute &amp; play, standard bridge</td>
<td>-65</td>
<td>-</td>
<td>65</td>
<td>mV</td>
</tr>
<tr>
<td>( I_{SB} )</td>
<td>Standby current consumption</td>
<td>( V_{st-by} = 0 ) V</td>
<td>1</td>
<td>5</td>
<td>μA</td>
<td></td>
</tr>
<tr>
<td>( PSRR )</td>
<td>Power supply rejection ratio</td>
<td>( f = 100 ) Hz to 10 kHz; ( V_r = 1 ) Vpk; ( R_g = 600 ) Ω</td>
<td>60</td>
<td>75</td>
<td>-</td>
<td>dB</td>
</tr>
<tr>
<td>( T_{ON} )</td>
<td>Turn on delay</td>
<td>D2 (IB1) 0 to 1</td>
<td>-</td>
<td>30</td>
<td>50</td>
<td>ms</td>
</tr>
<tr>
<td>( T_{OFF} )</td>
<td>Turn off delay</td>
<td>D2 (IB1) 1 to 0</td>
<td>-</td>
<td>30</td>
<td>50</td>
<td>ms</td>
</tr>
<tr>
<td>( V_{MC} )</td>
<td>Max. common mode input level</td>
<td>( f = 1 ) kHz</td>
<td>-</td>
<td>-</td>
<td>1</td>
<td>Vrms</td>
</tr>
<tr>
<td>( SR )</td>
<td>Slew rate</td>
<td>-</td>
<td>-</td>
<td>2</td>
<td>4.5</td>
<td>V/μs</td>
</tr>
</tbody>
</table>

### Audio performances

#### Po (Output power)

<table>
<thead>
<tr>
<th>Max. power(^{(1)})</th>
<th>THD = 10 %</th>
<th>THD = 1 %</th>
<th>R(_L) = 2 (Ω); THD 10 %</th>
<th>R(_L) = 2 (Ω); THD 1 %</th>
<th>R(_L) = 2 (Ω); Max. power(^{(1)})</th>
<th>Single channel configuration</th>
<th>Max. power(^{(1)}), (V_s = 6 ) V</th>
<th>Max. power(^{(1)}), (V_s = 6 ) V, (R_L = 1 ) (Ω);</th>
</tr>
</thead>
<tbody>
<tr>
<td>40</td>
<td>25</td>
<td>28</td>
<td>45</td>
<td>50</td>
<td>40</td>
<td>70</td>
<td>80</td>
<td>85</td>
</tr>
</tbody>
</table>

#### THD (Total harmonic distortion)

<table>
<thead>
<tr>
<th>( P_O = 1-12 W; ) STD MODE</th>
<th>HE MODE; ( P_O = 1-2 W )</th>
<th>HE MODE; ( P_O = 4-8 W )</th>
<th>( P_O = 1-12 W, f = 10 ) kHz, STD MODE</th>
<th>( R_L = 2 ) (Ω); HE MODE; ( P_O = 3 W )</th>
<th>Single channel configuration</th>
<th>( R_L = 1 ) (Ω); ( P_O = 4-30 W )</th>
</tr>
</thead>
<tbody>
<tr>
<td>-</td>
<td>0.04</td>
<td>0.1</td>
<td>-</td>
<td>0.03</td>
<td>0.1</td>
<td>-</td>
</tr>
</tbody>
</table>

#### CT (Cross talk)

| \( R_g = 600 \) \(Ω\); \( P_O = 1 W \) | \( R_g = 600 \) \(Ω\); \( P_O = 1 W \) | 75 | 90 | - | dB |

#### \( G_{V1} \) (Voltage gain 1 (default))

| - | 25 | 26 | 27 | dB |

#### \( \Delta G_{V1} \) (Voltage gain match 1)

| - | -1 | - | 1 | dB |

#### \( G_{V2} \) (Voltage gain 2)

| - | 15 | 16 | 17 | dB |

#### \( \Delta G_{V2} \) (Voltage gain match 2)

| - | -1 | - | 1 | dB |
### Electrical specifications

#### Table 4. Electrical characteristics (continued)

<table>
<thead>
<tr>
<th>Symbol</th>
<th>Parameter</th>
<th>Test condition</th>
<th>Min.</th>
<th>Typ.</th>
<th>Max.</th>
<th>Unit</th>
</tr>
</thead>
<tbody>
<tr>
<td>$E_{IN1}$</td>
<td>Output noise voltage gain 1</td>
<td>$R_g = 600 \Omega; G_v = 26 \text{ dB}$ filter 20 to 22 kHz</td>
<td>-</td>
<td>45</td>
<td>60</td>
<td>$\mu\text{V}$</td>
</tr>
<tr>
<td>$E_{IN2}$</td>
<td>Output noise voltage gain 2</td>
<td>$R_g = 600 \Omega; G_v = 16 \text{ dB}$ filter 20 to 22 kHz</td>
<td>-</td>
<td>20</td>
<td>30</td>
<td>$\mu\text{V}$</td>
</tr>
<tr>
<td>BW</td>
<td>Power bandwidth</td>
<td>(-3 dB)</td>
<td>100</td>
<td>-</td>
<td>-</td>
<td>kHz</td>
</tr>
<tr>
<td>CMRR</td>
<td>Input CMRR</td>
<td>$V_{CM} = 1 \text{ Vpk-pk}; R_g = 0 \Omega$</td>
<td>55</td>
<td>70</td>
<td>-</td>
<td>dB</td>
</tr>
<tr>
<td>$\Delta V_{OITU}$</td>
<td>ITU Pop filter output voltage</td>
<td>Standby to Mute and Mute to Standby transition ITU-R 2K, $C_{svr} = 10 \mu\text{F}$</td>
<td>-7.5</td>
<td>-</td>
<td>+7.5</td>
<td>$\text{mV}$</td>
</tr>
<tr>
<td></td>
<td></td>
<td>Mute to Play transition:</td>
<td></td>
<td></td>
<td></td>
<td></td>
</tr>
<tr>
<td></td>
<td></td>
<td>Low gain</td>
<td>-7.5</td>
<td>-</td>
<td>+7.5</td>
<td>$\text{mV}$</td>
</tr>
<tr>
<td></td>
<td></td>
<td>High gain</td>
<td>-12</td>
<td>-</td>
<td>+12</td>
<td>$\text{mV}$</td>
</tr>
<tr>
<td></td>
<td></td>
<td>ITU-R 2K (2)</td>
<td></td>
<td></td>
<td></td>
<td></td>
</tr>
<tr>
<td></td>
<td></td>
<td>Play to Mute transition:</td>
<td></td>
<td></td>
<td></td>
<td></td>
</tr>
<tr>
<td></td>
<td></td>
<td>Low gain</td>
<td>-7.5</td>
<td>-</td>
<td>+7.5</td>
<td>$\text{mV}$</td>
</tr>
<tr>
<td></td>
<td></td>
<td>High gain</td>
<td>-12</td>
<td>-</td>
<td>+12</td>
<td>$\text{mV}$</td>
</tr>
<tr>
<td></td>
<td></td>
<td>ITU-R 2K (3)</td>
<td></td>
<td></td>
<td></td>
<td></td>
</tr>
<tr>
<td><strong>Clip detector</strong></td>
<td></td>
<td>Clip pin high leakage current</td>
<td>-5</td>
<td>-</td>
<td>5</td>
<td>$\mu\text{A}$</td>
</tr>
<tr>
<td></td>
<td>Clip pin low sink current</td>
<td>CD on; $V_{CD} &lt; 300 \text{ mV}$</td>
<td>1</td>
<td>-</td>
<td>-</td>
<td>mA</td>
</tr>
<tr>
<td>CD</td>
<td>Clip detect THD level</td>
<td>$D0 (IB1) = 0$</td>
<td>1</td>
<td>2</td>
<td>3</td>
<td>%</td>
</tr>
<tr>
<td></td>
<td></td>
<td>$D0 (IB1) = 1$</td>
<td>5</td>
<td>10</td>
<td>15</td>
<td>%</td>
</tr>
<tr>
<td><strong>Control pin characteristics</strong></td>
<td></td>
<td>ST-BY pin for standby (4)</td>
<td>0</td>
<td>-</td>
<td>1.2</td>
<td>V</td>
</tr>
<tr>
<td></td>
<td>ST-BY pin for standard bridge</td>
<td>$V_{SB}$</td>
<td>2.6</td>
<td>-</td>
<td>5</td>
<td>V</td>
</tr>
<tr>
<td></td>
<td>ST-BY pin for Hi-eff</td>
<td>$V_{HE}$</td>
<td>7</td>
<td>-</td>
<td>18</td>
<td>V</td>
</tr>
<tr>
<td>$I_{O (ST-BY)}$</td>
<td>ST-BY pin current</td>
<td>$1.2 \text{ V} &lt; V_{st-by/HE} &lt; 18 \text{ V}$</td>
<td>-</td>
<td>150</td>
<td>200</td>
<td>$\mu\text{A}$</td>
</tr>
<tr>
<td></td>
<td>ST-BY pin current</td>
<td>$V_{st-by} &lt; 1.2 \text{ V}$</td>
<td>-</td>
<td>1</td>
<td>5</td>
<td>$\mu\text{A}$</td>
</tr>
<tr>
<td>$V_m$</td>
<td>Mute pin voltage for mute mode</td>
<td>$V_{mute} = 0 \text{ V}, V_{st-by} &lt; 1.2 \text{ V}$</td>
<td>-</td>
<td>-</td>
<td>1</td>
<td>V</td>
</tr>
<tr>
<td></td>
<td>Mute pin voltage for play mode</td>
<td>$V_{m} = 2.6 \text{ V}$</td>
<td>-</td>
<td>18</td>
<td>-</td>
<td>V</td>
</tr>
<tr>
<td>$I_m$</td>
<td>Mute pin current (st_by)</td>
<td>$0 \text{ V} &lt; V_{mute} &lt; 18 \text{ V}, V_{st-by} &gt; 2.6 \text{ V}$</td>
<td>-</td>
<td>60</td>
<td>100</td>
<td>$\mu\text{A}$</td>
</tr>
<tr>
<td></td>
<td>Mute pin current (operative)</td>
<td>$0 \text{ V} &lt; I^{2}\text{C EN} &lt; 18 \text{ V}, V_{st-by} &lt; 1.2 \text{ V}$</td>
<td>-5</td>
<td>-</td>
<td>5</td>
<td>$\mu\text{A}$</td>
</tr>
<tr>
<td>$V_{I^{2}\text{C}}$</td>
<td>$I^{2}\text{C pin voltage for }I^{2}\text{C disabled}$</td>
<td>$0 \text{ V} &lt; I^{2}\text{C EN} &lt; 18 \text{ V}, V_{st-by} &gt;2.6 \text{ V}$</td>
<td>-</td>
<td>7</td>
<td>13</td>
<td>18</td>
</tr>
<tr>
<td></td>
<td>$I^{2}\text{C pin current (standby)}$</td>
<td>$0 \text{ V} &lt; I^{2}\text{C EN} &lt; 18 \text{ V}, V_{st-by} &lt; 1.2 \text{ V}$</td>
<td>-5</td>
<td>-</td>
<td>5</td>
<td>$\mu\text{A}$</td>
</tr>
<tr>
<td></td>
<td>$I^{2}\text{C pin current (operative)}$</td>
<td>$I^{2}\text{C EN} &lt; 18 \text{ V}, V_{st-by}&gt;2.6 \text{ V}$</td>
<td>-</td>
<td>7</td>
<td>13</td>
<td>18</td>
</tr>
</tbody>
</table>
Table 4. Electrical characteristics (continued)

<table>
<thead>
<tr>
<th>Symbol</th>
<th>Parameter Description</th>
<th>Test condition</th>
<th>Min.</th>
<th>Typ.</th>
<th>Max.</th>
<th>Unit</th>
</tr>
</thead>
<tbody>
<tr>
<td>( V_{1\Omega} )</td>
<td>1Ω pin voltage for 2ch mode</td>
<td>-</td>
<td>0</td>
<td>-</td>
<td>1.5</td>
<td>V</td>
</tr>
<tr>
<td>( V_{1\Omega} )</td>
<td>1Ω pin voltage for 1 Ω mode</td>
<td>-</td>
<td>2.5</td>
<td>-</td>
<td>18</td>
<td>V</td>
</tr>
<tr>
<td>( I_{1\Omega} )</td>
<td>1Ω pin current (standby)</td>
<td>0 V &lt; 1 Ω &lt; 18 V, ( V_{st-by} &lt; 1.2 \ V )</td>
<td>-5</td>
<td>-</td>
<td>5</td>
<td>μA</td>
</tr>
<tr>
<td>( I_{1\Omega} )</td>
<td>1Ω pin current (operative)</td>
<td>1 Ω &lt; 18 V, ( V_{st-by} &gt; 2.6 \ V )</td>
<td>7</td>
<td>13</td>
<td>18</td>
<td>μA</td>
</tr>
<tr>
<td>( L_a )</td>
<td>A pin voltage</td>
<td>Low logic level</td>
<td>0</td>
<td>-</td>
<td>1.5</td>
<td>V</td>
</tr>
<tr>
<td>( H_a )</td>
<td>A pin current</td>
<td>High logic level</td>
<td>2.5</td>
<td>-</td>
<td>18</td>
<td>V</td>
</tr>
<tr>
<td>( I_a )</td>
<td>A pin current (ST-BY)</td>
<td>0 V &lt; A &lt; 18 V, ( V_{st-by} &lt; 1.2 \ V )</td>
<td>-5</td>
<td>-</td>
<td>5</td>
<td>μA</td>
</tr>
<tr>
<td>( I_a )</td>
<td>A pin current (operative)</td>
<td>A &lt; 18 V, ( V_{st-by} &gt; 2.6 \ V )</td>
<td>7</td>
<td>13</td>
<td>18</td>
<td>μA</td>
</tr>
<tr>
<td>( L_b )</td>
<td>B pin voltage</td>
<td>Low logic level</td>
<td>0</td>
<td>-</td>
<td>1.5</td>
<td>V</td>
</tr>
<tr>
<td>( H_b )</td>
<td>B pin current</td>
<td>High logic level</td>
<td>2.5</td>
<td>-</td>
<td>18</td>
<td>V</td>
</tr>
<tr>
<td>( I_b )</td>
<td>B pin current (ST-BY)</td>
<td>0V &lt; B &lt; 18 V, ( V_{st-by} &lt; 1.2 \ V )</td>
<td>-5</td>
<td>-</td>
<td>5</td>
<td>μA</td>
</tr>
<tr>
<td>( I_b )</td>
<td>B pin current (operative)</td>
<td>B &lt; 18 V, ( V_{st-by} &gt; 2.6 \ V )</td>
<td>7</td>
<td>13</td>
<td>18</td>
<td>μA</td>
</tr>
<tr>
<td>( A_{SB} )</td>
<td>Standby attenuation</td>
<td>-</td>
<td>90</td>
<td>100</td>
<td>-</td>
<td>dB</td>
</tr>
<tr>
<td>( A_{M} )</td>
<td>Mute attenuation</td>
<td>-</td>
<td>80</td>
<td>100</td>
<td>-</td>
<td>dB</td>
</tr>
</tbody>
</table>

Turn on diagnostics (Power amplifier mode)

<table>
<thead>
<tr>
<th>Symbol</th>
<th>Description</th>
<th>Power amplifier in standby condition</th>
<th>Min.</th>
<th>Typ.</th>
<th>Max.</th>
<th>Unit</th>
</tr>
</thead>
<tbody>
<tr>
<td>( P_{gnd} )</td>
<td>Short to GND det. (below this limit, the Output is considered in Short Circuit to GND)</td>
<td>-</td>
<td>-</td>
<td>1.2</td>
<td>V</td>
<td></td>
</tr>
<tr>
<td>( P_{vs} )</td>
<td>Short to Vs det. (above this limit, the Output is considered in Short Circuit to VS)</td>
<td>( V_s ) - 0.9</td>
<td>-</td>
<td>-</td>
<td>V</td>
<td></td>
</tr>
<tr>
<td>( P_{nop} )</td>
<td>Normal operation thresholds. (Within these limits, the Output is considered without faults)</td>
<td>-</td>
<td>1.8</td>
<td>-</td>
<td>( V_s ) - 1.5</td>
<td>V</td>
</tr>
<tr>
<td>( L_{sc} )</td>
<td>Shorted load det.</td>
<td>-</td>
<td>-</td>
<td>0.5</td>
<td>Ω</td>
<td></td>
</tr>
<tr>
<td>( L_{op} )</td>
<td>Open load det.</td>
<td>85</td>
<td>-</td>
<td>-</td>
<td>Ω</td>
<td></td>
</tr>
<tr>
<td>( L_{nop} )</td>
<td>Normal load det.</td>
<td>-</td>
<td>1.5</td>
<td>-</td>
<td>45</td>
<td>Ω</td>
</tr>
</tbody>
</table>

Turn on diagnostics (Line driver mode)

<table>
<thead>
<tr>
<th>Symbol</th>
<th>Description</th>
<th>Power amplifier in standby</th>
<th>Min.</th>
<th>Typ.</th>
<th>Max.</th>
<th>Unit</th>
</tr>
</thead>
<tbody>
<tr>
<td>( P_{gnd} )</td>
<td>Short to GND det. (below this limit, the Output is considered in Short Circuit to GND)</td>
<td>-</td>
<td>-</td>
<td>1.2</td>
<td>V</td>
<td></td>
</tr>
<tr>
<td>( P_{vs} )</td>
<td>Short to Vs det. (above this limit, the Output is considered in Short Circuit to VS)</td>
<td>( V_s ) - 0.9</td>
<td>-</td>
<td>-</td>
<td>V</td>
<td></td>
</tr>
<tr>
<td>( P_{nop} )</td>
<td>Normal operation thresholds. (Within these limits, the Output is considered without faults)</td>
<td>1.8</td>
<td>-</td>
<td>1.5</td>
<td>V</td>
<td></td>
</tr>
<tr>
<td>( L_{sc} )</td>
<td>Shorted load det.</td>
<td>-</td>
<td>-</td>
<td>1.5</td>
<td>Ω</td>
<td></td>
</tr>
<tr>
<td>( L_{op} )</td>
<td>Open load det.</td>
<td>330</td>
<td>-</td>
<td>-</td>
<td>Ω</td>
<td></td>
</tr>
</tbody>
</table>
### Electrical specifications

#### Table 4. Electrical characteristics (continued)

<table>
<thead>
<tr>
<th>Symbol</th>
<th>Parameter</th>
<th>Test condition</th>
<th>Min.</th>
<th>Typ.</th>
<th>Max.</th>
<th>Unit</th>
</tr>
</thead>
<tbody>
<tr>
<td>Lnop</td>
<td>Normal load det.</td>
<td>Power amplifier in standby</td>
<td>4.5</td>
<td>-</td>
<td>180</td>
<td>Ω</td>
</tr>
</tbody>
</table>

#### Permanent diagnostics (Power amplifier mode or line driver mode)

<table>
<thead>
<tr>
<th>Symbol</th>
<th>Parameter</th>
<th>Test condition</th>
<th>Min.</th>
<th>Typ.</th>
<th>Max.</th>
<th>Unit</th>
</tr>
</thead>
<tbody>
<tr>
<td>Pgnd</td>
<td>Short to GND det. (below this limit, the Output is considered in Short Circuit to GND)</td>
<td>Power amplifier in Mute or Play condition, one or more short circuits protection activated</td>
<td>-</td>
<td>-</td>
<td>1.2</td>
<td>V</td>
</tr>
<tr>
<td>Pvs</td>
<td>Short to Vs det. (above this limit, the Output is considered in Short Circuit to VS)</td>
<td>-</td>
<td>V&lt;sub&gt;s&lt;/sub&gt;</td>
<td>-</td>
<td>-</td>
<td>V</td>
</tr>
<tr>
<td>Pnop</td>
<td>Normal operation thresholds. (Within these limits, the Output is considered without faults)</td>
<td>-</td>
<td>1.8</td>
<td>-</td>
<td>V&lt;sub&gt;s&lt;/sub&gt;</td>
<td>V</td>
</tr>
<tr>
<td>Lsc</td>
<td>Shorted load det.</td>
<td>Pow. amp. mode</td>
<td>-</td>
<td>-</td>
<td>0.5</td>
<td>Ω</td>
</tr>
<tr>
<td>Lsc</td>
<td>Shorted load det.</td>
<td>Line driver mode</td>
<td>-</td>
<td>-</td>
<td>1.5</td>
<td>Ω</td>
</tr>
<tr>
<td>VO</td>
<td>Offset detection</td>
<td>Power amplifier in play condition AC input signals = 0</td>
<td>±1.5</td>
<td>±2</td>
<td>±2.5</td>
<td>V</td>
</tr>
<tr>
<td>I&lt;sub&gt;NLH&lt;/sub&gt;</td>
<td>Normal load current detection</td>
<td>V&lt;sub&gt;O&lt;/sub&gt; &lt; (V&lt;sub&gt;S&lt;/sub&gt; - 5)pk IB2 (D0) = 0</td>
<td>500</td>
<td>-</td>
<td>-</td>
<td>mA</td>
</tr>
<tr>
<td>I&lt;sub&gt;NLL&lt;/sub&gt;</td>
<td>Normal load current detection</td>
<td>V&lt;sub&gt;O&lt;/sub&gt; &lt; (V&lt;sub&gt;S&lt;/sub&gt; - 5)pk IB2 (D0) = 1</td>
<td>250</td>
<td>-</td>
<td>-</td>
<td>mA</td>
</tr>
<tr>
<td>I&lt;sub&gt;OLH&lt;/sub&gt;</td>
<td>Open load current detection</td>
<td>V&lt;sub&gt;O&lt;/sub&gt; &lt; (V&lt;sub&gt;S&lt;/sub&gt; - 5)pk IB2 (D0) = 0</td>
<td>-</td>
<td>-</td>
<td>250</td>
<td>mA</td>
</tr>
<tr>
<td>I&lt;sub&gt;OLL&lt;/sub&gt;</td>
<td>Open load current detection</td>
<td>V&lt;sub&gt;O&lt;/sub&gt; &lt; (V&lt;sub&gt;S&lt;/sub&gt; - 5)pk IB2 (D0) = 1</td>
<td>-</td>
<td>-</td>
<td>125</td>
<td>mA</td>
</tr>
</tbody>
</table>

#### I<sup>2</sup>C bus interface

<table>
<thead>
<tr>
<th>Symbol</th>
<th>Parameter</th>
<th>Test condition</th>
<th>Min.</th>
<th>Typ.</th>
<th>Max.</th>
<th>Unit</th>
</tr>
</thead>
<tbody>
<tr>
<td>f&lt;sub&gt;SCL&lt;/sub&gt;</td>
<td>Clock frequency</td>
<td>-</td>
<td>-</td>
<td>-</td>
<td>400</td>
<td>kHz</td>
</tr>
<tr>
<td>V&lt;sub&gt;IL&lt;/sub&gt;</td>
<td>Input low voltage</td>
<td>-</td>
<td>-</td>
<td>-</td>
<td>1.5</td>
<td>V</td>
</tr>
<tr>
<td>V&lt;sub&gt;IH&lt;/sub&gt;</td>
<td>Input high voltage</td>
<td>-</td>
<td>2.3</td>
<td>-</td>
<td>-</td>
<td>V</td>
</tr>
</tbody>
</table>

1. Saturated square wave output.
2. Voltage ramp on Mute pin:
   from 350 mV to 3.05 V in 40 ms.
   In case of I<sup>2</sup>C interface enabled command IB1(D2)=1 (Mute->Unmute) must be transmitted before to start the voltage ramp on Mute pin.
3. Voltage ramp on Mute pin:
   from 2.8 V to 1.2 V in 40 ms.
   In case of I<sup>2</sup>C interface enabled the I<sup>2</sup>C command IB1(D2)=0 (Unmute->Mute) must be NOT transmitted before to start the voltage ramp on Mute pin.
4. ST-BY pin high enables the I<sup>2</sup>C bus; ST-BY pin low enables ST-BY condition: detailed pin levels description is contained in paragraph 'I<sup>2</sup>C habilitation settings'.
3.4 Electrical characteristics typical curves

Figure 4. Quiescent drain current vs. supply voltage

Figure 5. Output power vs. supply voltage (4 Ω)

Figure 6. Output power vs. supply voltage (2 Ω)

Figure 7. Output power vs. supply voltage (1 Ω)

Figure 8. Distortion vs. output power (4 Ω, STD mode)

Figure 9. Distortion vs. output power (2 Ω, STD mode)
Electrical specifications

**Figure 10. Distortion vs. output power (2 Ω, HI-EFF mode)**

**Figure 11. Distortion vs. output power (1 Ω, STD mode)**

**Figure 12. Distortion vs. frequency (4 Ω load)**

**Figure 13. Distortion vs. frequency (2 Ω load)**

**Figure 14. Distortion vs. frequency (1 Ω load)**

**Figure 15. Output attenuation vs. supply voltage**
Figure 16. CMRR vs. frequency

Figure 17. Cross talk vs frequency

Figure 18. Power dissipation vs. average Po (2 Ω, STD mode, sine wave)

Figure 19. Power dissipation vs. Po (2 Ω, STD mode, audio program simulation)

Figure 20. Power dissipation vs. average Po (2Ω, HI-EFF mode)

Figure 21. Power dissipation vs. Po (1 Ω, STD mode, audio program simulation)
Figure 22. ITU R-ARM frequency response, weighting filter for transient pop
4  Diagnostics functional description

4.1 Turn-on diagnostic

It is strongly recommended to activate this function at the turn-on (standby out) through I²C bus request. Detectable output faults are:

- SHORT TO GND
- SHORT TO Vs
- SHORT ACROSS THE SPEAKER
- OPEN SPEAKER

To verify if any of the above misconnections is in place, a subsonic (inaudible) current pulse (Figure 23) is internally generated, sent through the speaker(s) and sunk back. The Turn-on diagnostic status is internally stored until a successive diagnostic pulse is requested (after a I²C reading).

If the "standby out" and "diag. enable" commands are both given through a single programming step, the pulse takes place first (during the pulse power stages stay off, showing high impedance at the outputs).

Afterwards, when the Amplifier is biased, the permanent diagnostic takes place. The previous turn-on state is kept until a short appears at the outputs.

Figure 23. Turn-on diagnostic: working principle

Fig. Figure 24 and Figure 25 show SVR and OUTPUT waveforms at the turn-on (standby out) with and without turn-on diagnostic.

Figure 24. SVR and output behavior - case 1: without turn-on diagnostic
The information related to the outputs status is read and memorized at the end of the current pulse plateau. The acquisition time is 100 ms (typ.). No audible noise is generated in the process. As for SHORT TO GND / Vs the fault-detection thresholds remain unchanged from 26 dB to 16 dB gain setting. They are as follows:

Figure 26. Short circuit detection thresholds

Concerning SHORT ACROSS THE SPEAKER / OPEN SPEAKER, the threshold varies from 26 dB to 16 dB gain setting, since different loads are expected (either normal speaker’s impedance or high impedance). The values in case of 26 dB gain are as follows:

Figure 27. Load detection thresholds - high gain setting

If the Line-Driver mode (Gv = 16 dB and Line Driver Mode diagnostic = 1) is selected, the same thresholds will change as follows:

Figure 28. Load detection thresholds - high gain setting
4.2 Permanent diagnostics

Detectable conventional faults are:

- SHORT TO GND
- SHORT TO Vs
- SHORT ACROSS THE SPEAKER

The following additional feature is provided:
- OUTPUT OFFSET DETECTION

The TDA7577BLV has 2 operating status:

1. RESTART mode. The diagnostic is not enabled. Each audio channel operates independently of each other. If any of the a.m. faults occurs, only the channel(s) interested is shut down. A check of the output status is made every 1 ms (Figure 29). Restart takes place when the overload is removed.

2. DIAGNOSTIC mode. It is enabled via I²C bus and it self activates if an output overload (such as to cause the intervention of the short-circuit protection) occurs to the speakers outputs. Once activated, the diagnostics procedure develops as follows (Figure 30):
   - To avoid momentary re-circulation spikes from giving erroneous diagnostics, a check of the output status is made after 1ms: if normal situation (no overloads) is detected, the diagnostic is not performed and the channel returns active.
   - Instead, if an overload is detected during the check after 1 ms, then a diagnostic cycle having a duration of about 100 ms is started.
   - After a diagnostic cycle, the audio channel interested by the fault is switched to RESTART mode. The relevant data are stored inside the device and can be read by the microprocessor. When one cycle has terminated, the next one is activated by an I²C reading. This is to ensure continuous diagnostics throughout the car-radio operating time.
   - To check the status of the device a sampling system is needed. The timing is chosen at microprocessor level (more than half a second is recommended).

Figure 29. Restart timing without diagnostic enable (permanent) each 1ms time, a sampling of the fault is done

Figure 30. Restart timing with diagnostic enable (permanent)
4.3 Output DC offset detection

Any DC output offset exceeding ± 2 V is signalled out. This inconvenience might occur as a consequence of initially defective or aged and worn-out input capacitors feeding a DC component to the inputs, so putting the speakers at risk of overheating.

This diagnostic has to be performed with low-level output AC signal (or Vin = 0).

The test is run with selectable time duration by microprocessor (from a "start" to a "stop" command):

- **START** = Last reading operation or setting IB1 - D5 - (OFFSET enable) to 1
- **STOP** = Actual reading operation

Excess offset is signalled out if it is persistent for all the assigned testing time. This feature is disabled if any overloads leading to activation of the short-circuit protection occurs in the process.

4.4 AC diagnostic

It is targeted at detecting accidental disconnection of tweeters in 2-way speaker and, more in general, presence of capacitively (AC) coupled loads.

This diagnostic is based on the notion that the overall speaker's impedance (woofer + parallel tweeter) will tend to increase towards high frequencies if the tweeter gets disconnected, because the remaining speaker (woofer) would be out of its operating range (high impedance). The diagnostic decision is made according to peak output current thresholds, and it is enabled by setting (IB2-D2) = 1. Two different detection levels are available:

- **HIGH CURRENT THRESHOLD IB2 (D7) = 0**
  - \( I_{out} > 500 \text{ mApk} = \text{NORMAL STATUS} \)
  - \( I_{out} < 250 \text{ mApk} = \text{OPEN TWEETER} \)

- **LOW CURRENT THRESHOLD IB2 (D7) = 1**
  - \( I_{out} > 250 \text{ mApk} = \text{NORMAL STATUS} \)
  - \( I_{out} < 125 \text{ mApk} = \text{OPEN TWEETER} \)

To correctly implement this feature, it is necessary to briefly provide a signal tone (with the amplifier in "play") whose frequency and magnitude are such as to determine an output current higher than 500 mApk with IB2(D7) = 0 (higher than 250 mApk with IB2(D7) = 1) in normal conditions and lower than 250 mApk with IB2(D7) = 0 (lower than 125 mApk with IB2(D7) = 1) should the parallel tweeter be missing.

The test has to last for a minimum number of 3 sine cycles starting from the activation of the AC diagnostic function IB2<D2>) up to the I\(^2\)C reading of the results (measuring period). To confirm presence of tweeter, it is necessary to find at least 3 current pulses exceeding the above threshold over all the measuring period, else an "open tweeter" message will be issued.

The frequency / magnitude setting of the test tone depends on the impedance characteristics of each specific speaker being used, with or without the tweeter connected (to be calculated case by case). High-frequency tones (> 10 kHz) or even ultrasonic signals are recommended for their negligible acoustic impact and also to maximize the impedance module's ratio between with tweeter-on and tweeter-off.
Figure 31 and 32 shows the load impedance as a function of the peak output voltage and the relevant diagnostic fields.

It is recommended to keep output voltage always below 8 V (high threshold) or 4 V (low threshold) to avoid circuit to saturate (causing wrong detection cases).

This feature is disabled if any overloads leading to activation of the short-circuit protection occurs in the process.

Figure 31. Current detection high: load impedance |Z| vs. output peak voltage

Figure 32. Current detection low: load impedance |Z| vs. output peak voltage
4.5 Multiple faults

When more misconnections are simultaneously in place at the audio outputs, it is guaranteed that at least one of them is initially read out. The others are notified after successive cycles of I²C reading and faults removal, provided that the diagnostic is enabled. This is true for both kinds of diagnostic (Turn on and Permanent).

The table below shows all the couples of double-fault possible. It should be taken into account that a short circuit with the 4 Ω speaker unconnected is considered as double fault.

Table 5. Double fault table for turn on diagnostic

<table>
<thead>
<tr>
<th></th>
<th>S. GND</th>
<th>S. Vs</th>
<th>S. Across L.</th>
<th>Open L.</th>
</tr>
</thead>
<tbody>
<tr>
<td>S. GND</td>
<td>S. GND</td>
<td>S. Vs + S. GND</td>
<td>S. GND</td>
<td>S. GND</td>
</tr>
<tr>
<td>S. Vs</td>
<td>/</td>
<td>S. Vs</td>
<td>S. Vs</td>
<td>S. Vs</td>
</tr>
<tr>
<td>S. Across L.</td>
<td>/</td>
<td>/</td>
<td>S. Across L.</td>
<td>N.A.</td>
</tr>
<tr>
<td>Open L.</td>
<td>/</td>
<td>/</td>
<td>/</td>
<td>Open L. (*)</td>
</tr>
</tbody>
</table>

In Permanent Diagnostic the table is the same, with only a difference concerning Open Load(*), which is not among the recognizable faults. Should an Open Load be present during the device’s normal working, it would be detected at a subsequent Turn on Diagnostic cycle (i.e. at the successive car radio turn-on).

4.6 Fault presence information availability on I²C

All the results coming from I²C bus, by read operations, are the consequence of measurements inside a defined period of time. If the fault is stable throughout the whole period, it will be sent out. This is true for DC diagnostic (Turn-on and Permanent), for offset detector.

To guarantee always resident functions, every kind of diagnostic cycles (turn-on, Permanent, Offset) will be reactivated after any I²C reading operation. Each I²C read-out done by the microcontroller will enable a new diagnostic cycle, but the read data will come from the previous diagnostic cycle (i.e. The device is in turn-on state, with a short to GND, then the short is removed and micro reads I²C. The short to GND is still present in bytes, because it is the result of the previous cycle. If another I²C reading operation occurs, the bytes do not show the short). In general to observe a change in diagnostic bytes, two I²C reading operations are necessary.
5 1 Ω load capability setting

It is possible to drive 1 Ω load paralleling the outputs into a single channel.

In order to implement this feature, outputs should be connected as follows:

OUT1+ shorted to OUT2+
OUT1- shorted to OUT2-.

It is recommended to minimize the impedance on the board between OUT2 and the load in order to minimize THD distortion. It is also recommended to control the maximum mismatch impedance between $V_{CC}$ pins (PIN21/PIN22 respect to PIN33/PIN34) and between PWGND pins (PIN24/PIN25 respect to PIN30/PIN31), mismatch that must not exceed a value of 20 mΩ.

With 1Ω feature settled the active input is IN2 (PIN17 and PIN18), therefore IN1 pins should be left floating.

It is possible to set the load capability acting on 1 Ω pin as follows:

1 Ω PIN < 1.2V: two channels mode (for a minimum load of 2 Ω)
1 Ω PIN > 2.6V: one channel mode (for 1 Ω load).

It is to remember that 1 Ω function is a hardware selection.

Therefore, it is recommended to leave 1 Ω pin floating or shorted to GND to set the two channels mode configuration, or to short 1 Ω pin to $V_{CC}$ to set the one channel (1 Ω) configuration.
6 Battery transitions management

6.1 Low voltage operation (“start stop”)

The most recent OEM specifications require automatic stop of car engine at traffic light, in order to reduce emissions of polluting substances. The TDA7577BLV, thanks to its innovating design, is able to play when battery falls down to 6/7 V during such conditions, without producing audible pop noise. The maximum system power will be reduced accordingly.

Worst case battery cranking curves are shown below, indicating the shape and duration of allowed battery transitions.

**Figure 33. Worst case battery cranking curve sample 1**

V1 = 12 V; V2 = 6 V; V3 = 7 V; V4 = 8 V

t1 = 2 ms; t2 = 50 ms; t3 = 5 ms; t4 = 300 ms; t5 = 10 ms; t6 = 1 s; t7 = 2 ms

**Figure 34. Worst case battery cranking curve sample 2**

V1 = 12 V; V2 = 6 V; V3 = 7 V

t1 = 2 ms; t2 = 5 ms; t3 = 15 ms; t5 = 1 s; t6 = 50 ms
6.2 Advanced battery management

In addition to compatibility with low $V_{\text{batt}}$, the TDA7577BLV is able to sustain upwards fast battery transitions (like the one showed in Figure 35) without causing unwanted audible effect, thanks to the innovative circuit topology.

Figure 35. Upwards fast battery transitions diagram
7 I²C mode and legacy mode selection

It is possible to disable the I²C interface by acting on I2C EN pin and control the TDA7577BLV by means of the usual ST-BY and MUTE pins. In order to activate or deactivate this feature, I2C-EN must be set as follows:

- **I2C-EN (PIN16) < 1.5 V:**
  - I²C bus interface deactivated
- **I2C-EN (PIN16) > 2.5 V:**
  - I²C bus interface activated

(It is also possible to let I2C-EN PIN floating to deactivate the I²C bus interface, or to short to VCC to activate I²C).

In particular:

When I²C is ENABLED: (I2C-EN pin > 2.5 V) then there are the following modes:

- **STD MODE:** $V_{\text{stby}}$ (PIN5) > 2.6 V, IB2(D1)=0
- **HE MODE:** $V_{\text{stby}}$ (PIN5) > 2.6 V, IB2(D1)=1
- **PLAY MODE:** $V_{\text{mute}}$ (pin 4) > 2.6 V, IB1 (D2) = 1

The amplifier can always be switched off by putting $V_{\text{stby}}$ to 0V, but with I²C enabled it can be turn on only through I²C (with $V_{\text{stby}}$ > 2.6 V).

When I²C is DISABLED: (I2C pin < 1.5 V) then there are the following modes:

- **STD MODE:** 2.6 V < ST-BY (PIN5) < 5 V
- **HE MODE:** $V_{\text{stby}}$ (PIN5) > 7 V
- **PLAY MODE:** $V_{\text{mute}}$ (pin 4) > 2.6 V

For both STD and HE MODE the play/mute mode can be set acting on $V_{\text{mute}}$ pin.

In legacy mode (I²C disabled), faults (diagnostics information) are available on HW pin CD-Out. CD-Out pin is active on a low value [CD-Out low = fault detected]. The faults detected are: short to ground or $V_{\text{CC}}$, short across the load.
8 Application suggestions

8.1 High efficiency introduction

Thanks to its operating principle, the TDA7577BLV obtains a substantial reduction of power dissipation from traditional class-AB amplifiers without being affected by the massive radiation effects and complex circuitry normally associated with class-D solutions.

The high efficiency operating principle is based on the use of bridge structures which are connected by means of a power switch (Figure 1). The switch, controlled by a logic circuit which senses the input signals, is closed at low volumes (output power steadily lower than 2.5 W) and the system acts like a "single bridge" with double load. In this case, the total power dissipation is a quarter of a double bridge.

Due to its structure, the highest efficiency level can be reached when symmetrical loads are applied on channels sharing the same switch.

Figure 36. High efficiency - basic structure

When the power demand increases to more than 2.5 W, the system behavior is switched back to a standard double bridge in order to guarantee the maximum output power, while in the 6 V start-stop devices the High Efficiency mode is automatically disabled at low $V_{CC}$ (7.3 V ±0.3 V). No need to re-program it when Vcc goes back to normal levels.

In the range 2-4 W (@ $V_{CC}$ = 14.4 V), with the High Efficiency mode, the dissipated power gets up to 50 % less than the value obtained with the standard mode.
9 I²C bus interface

Data transmission from microprocessor to the TDA7577BLV and vice versa takes place through the 2 wires I²C bus interface, consisting of the two lines SDA and SCL (pull-up resistors to positive supply voltage must be connected).

9.1 Data validity

As shown by Figure 37, the data on the SDA line must be stable during the high period of the clock. The HIGH and LOW state of the data line can only change when the clock signal on the SCL line is LOW.

9.2 Start and stop conditions

As shown by Figure 38 a start condition is a HIGH to LOW transition of the SDA line while SCL is HIGH. The stop condition is a LOW to HIGH transition of the SDA line while SCL is HIGH.

9.3 Byte format

Every byte transferred to the SDA line must contain 8 bits. Each byte must be followed by an acknowledge bit. The MSB is transferred first.

9.4 Acknowledge

The transmitter(*) puts a resistive HIGH level on the SDA line during the acknowledge clock pulse (see Figure 39). The receiver(**) has to pull-down (LOW) the SDA line during the acknowledge clock pulse, so that the SDA line is stable LOW during this clock pulse.

(*) Transmitter

- master (μP) when it writes an address to the TDA7577BLV
- slave (TDA7577BLV) when the μP reads a data byte from TDA7577BLV

(**) Receiver

- slave (TDA7577BLV) when the μP writes an address to the TDA7577BLV
- master (μP) when it reads a data byte from TDA7577BLV

Figure 37. Data validity on the I²C bus
9.5  $i^2$C programming/reading sequences

A correct turn on/off sequence with respect to the diagnostic timings and producing no audible noises could be as follows (after battery connection):

- TURN-ON: (STANDBY OUT + DIAG ENABLE) --- 1 s (min) --- MUTING OUT
- TURN-OFF: MUTING IN - wait for 50 ms - HW ST-BY IN (ST-BY pin ≤ 1.2 V)

Car Radio Installation: DIAG ENABLE (write) --- 200 ms --- $i^2$C read (repeat until All faults disappear).

- OFFSET TEST: Device in Play (no signal) --
- OFFSET ENABLE - 30 ms - $i^2$C reading

(repeat $i^2$C reading until high-offset message disappears).
10 Software specifications

All the functions of the TDA7577BLV are activated by I²C interface.

The bit 0 of the "ADDRESS BYTE" defines if the next bytes are write instruction (from μP to TDA7577BLV) or read instruction (from TDA7577BLV to μP).

Table 6. Address selection

<table>
<thead>
<tr>
<th>Bit</th>
<th>Selection</th>
</tr>
</thead>
<tbody>
<tr>
<td>A6</td>
<td>1</td>
</tr>
<tr>
<td>A5</td>
<td>1</td>
</tr>
<tr>
<td>A4</td>
<td>0</td>
</tr>
<tr>
<td>A3</td>
<td>1</td>
</tr>
<tr>
<td>A2</td>
<td>0</td>
</tr>
<tr>
<td>A1</td>
<td>B</td>
</tr>
<tr>
<td>A0</td>
<td>A</td>
</tr>
<tr>
<td>R/W</td>
<td>X</td>
</tr>
</tbody>
</table>

If R/W = 0, the μP sends 2 "Instruction Bytes": IB1 and IB2.

Table 7. IB1

<table>
<thead>
<tr>
<th>Bit</th>
<th>Instruction decoding bit</th>
</tr>
</thead>
<tbody>
<tr>
<td>D7</td>
<td>Supply voltage mute high threshold (D7 = 1)</td>
</tr>
<tr>
<td></td>
<td>Supply voltage mute low threshold (D7 = 0)</td>
</tr>
<tr>
<td>D6</td>
<td>Diagnostic enable (D6 = 1)</td>
</tr>
<tr>
<td></td>
<td>Diagnostic defeat (D6 = 0)</td>
</tr>
<tr>
<td>D5</td>
<td>Offset Detection enable (D5 = 1)</td>
</tr>
<tr>
<td></td>
<td>Offset Detection defeat (D5 = 0)</td>
</tr>
<tr>
<td>D4</td>
<td>Gain = 26 dB (D4 = 0)</td>
</tr>
<tr>
<td></td>
<td>Gain = 16 dB (D4 = 1)</td>
</tr>
<tr>
<td>D3</td>
<td>0</td>
</tr>
<tr>
<td>D2</td>
<td>Mute (D2 = 0)</td>
</tr>
<tr>
<td></td>
<td>Unmute (D2 = 1)</td>
</tr>
<tr>
<td>D1</td>
<td>0</td>
</tr>
<tr>
<td>D0</td>
<td>CD 2% (D0 = 0)</td>
</tr>
<tr>
<td></td>
<td>CD 10% (D0 = 1)</td>
</tr>
</tbody>
</table>
If R/W = 1, the TDA7577BLV sends 2 "Diagnostics Bytes" to μP: DB1 and DB2.

### Table 8. IB2

<table>
<thead>
<tr>
<th>Bit</th>
<th>Instruction decoding bit</th>
</tr>
</thead>
<tbody>
<tr>
<td>D7</td>
<td>Current Detection Threshold HIGH (D7 = 0)</td>
</tr>
<tr>
<td></td>
<td>Current Detection Threshold LOW (D7 = 1)</td>
</tr>
<tr>
<td>D6</td>
<td>0</td>
</tr>
<tr>
<td>D5</td>
<td>Fast muting disable - (D5 = 0)</td>
</tr>
<tr>
<td></td>
<td>Fast muting enable - (D5 = 1)</td>
</tr>
<tr>
<td>D4</td>
<td>Stand-by on - Amplifier not working - (D4 = 0)</td>
</tr>
<tr>
<td></td>
<td>Stand-by off - Amplifier working - (D4 = 1)</td>
</tr>
<tr>
<td>D3</td>
<td>Power Amplifier Mode Diagnostic (D3 = 0);</td>
</tr>
<tr>
<td></td>
<td>Line Driver Mode Diagnostic (D3 = 1)</td>
</tr>
<tr>
<td>D2</td>
<td>Current Detection Diagnostic Enabled (D2 = 1)</td>
</tr>
<tr>
<td></td>
<td>Current Detection Diagnostic Defeat (D2 = 0)</td>
</tr>
<tr>
<td>D1</td>
<td>Power amplifier working in standard mode (D1 = 0)</td>
</tr>
<tr>
<td></td>
<td>Power amplifier working in high efficiency mode (D1 = 1)</td>
</tr>
<tr>
<td>D0</td>
<td>0</td>
</tr>
</tbody>
</table>

### Table 9. DB1

<table>
<thead>
<tr>
<th>Bit</th>
<th>Instruction decoding bit</th>
</tr>
</thead>
<tbody>
<tr>
<td>D7</td>
<td>Thermal warning (if Tchip ≥ 140°C, D7 = 1)</td>
</tr>
<tr>
<td>D6</td>
<td>Diag. cycle not activated or not terminated (D6 = 0)</td>
</tr>
<tr>
<td></td>
<td>Diag. cycle terminated (D6 = 1)</td>
</tr>
<tr>
<td>D5</td>
<td>Channel 1</td>
</tr>
<tr>
<td></td>
<td>Current detection IB2 (D0) = 0</td>
</tr>
<tr>
<td></td>
<td>Output peak current &lt; 250 mA - Open load (D5 = 1)</td>
</tr>
<tr>
<td></td>
<td>Output peak current &gt; 500 mA - Normal load (D5 = 0)</td>
</tr>
<tr>
<td>D4</td>
<td>Channel 1</td>
</tr>
<tr>
<td></td>
<td>Turn-on diagnostic (D4 = 0)</td>
</tr>
<tr>
<td></td>
<td>Permanent diagnostic (D4 = 1)</td>
</tr>
<tr>
<td>D3</td>
<td>Channel 1</td>
</tr>
<tr>
<td></td>
<td>Normal load (D3 = 0)</td>
</tr>
<tr>
<td></td>
<td>Short load (D3 = 1)</td>
</tr>
<tr>
<td>D2</td>
<td>Channel 1</td>
</tr>
<tr>
<td></td>
<td>Turn-on diag.: No open load (D2 = 0)</td>
</tr>
<tr>
<td></td>
<td>Open load detection (D2 = 1)</td>
</tr>
<tr>
<td></td>
<td>Offset diag.: No output offset (D2 = 0)</td>
</tr>
<tr>
<td></td>
<td>Output offset detection (D2 = 1)</td>
</tr>
<tr>
<td>D1</td>
<td>Channel 1</td>
</tr>
<tr>
<td></td>
<td>No short to ( V_{cc} ) (D1 = 0)</td>
</tr>
<tr>
<td></td>
<td>Short to ( V_{cc} ) (D1 = 1)</td>
</tr>
<tr>
<td>D0</td>
<td>Channel 1</td>
</tr>
<tr>
<td></td>
<td>No short to GND (D0 = 0)</td>
</tr>
<tr>
<td></td>
<td>Short to GND (D0 = 1)</td>
</tr>
</tbody>
</table>
### Table 10. DB2

<table>
<thead>
<tr>
<th>Bit</th>
<th>Instruction decoding bit</th>
</tr>
</thead>
</table>
| D7  | Offset detection not activated (D7 = 0)  
|     | Offset detection activated (D7 = 1)      |
| D6  | Current sensor not activated (D6 = 0)    
|     | Current sensor activated (D6 = 1)        |
| D5  | Channel 2  
|     | Current detection IB2 (D0) = 0          
|     | Output peak current < 250 mA - Open load (D5 = 1)  
|     | Output peak current > 500 mA - Normal load (D5 = 0) |
|     | Channel 2  
|     | Current detection IB2 (D0) = 1          
|     | Output peak current < 125 mA - Open load (D5 = 1)  
|     | Output peak current > 250 mA - Normal load (D5 = 0) |
| D4  | Channel 2  
|     | Turn-on diagnostic (D4 = 0)              
|     | Permanent diagnostic (D4 = 1)            |
| D3  | Channel 2  
|     | Normal load (D3 = 0)                     
|     | Short load (D3 = 1)                      |
| D2  | Channel 2  
|     | Turn-on diag.: No open load (D2 = 0)     
|     | Open load detection (D2 = 1)             
|     | Permanent diag.: No output offset (D2 = 0)  
|     | Output offset detection (D2 = 1)         |
| D1  | Channel 2  
|     | No short to $V_{cc}$ (D1 = 0)            
|     | Short to $V_{cc}$ (D1 = 1)               |
| D0  | Channel 2  
|     | No short to GND (D0 = 0)                 
|     | Short to GND (D0 = 1)                    |
10.1 Examples of bytes sequence

1 - Turn-on diagnostic - Write operation

<table>
<thead>
<tr>
<th>Start</th>
<th>Address byte with D0 = 0</th>
<th>ACK</th>
<th>IB1</th>
<th>ACK</th>
<th>IB2</th>
<th>ACK</th>
<th>STOP</th>
</tr>
</thead>
</table>

2 - Turn-on diagnostic - Read operation

<table>
<thead>
<tr>
<th>Start</th>
<th>Address byte with D0 = 1</th>
<th>ACK</th>
<th>DB1</th>
<th>ACK</th>
<th>DB2</th>
<th>ACK</th>
<th>STOP</th>
</tr>
</thead>
</table>

The delay from 1 to 2 can be selected by software, starting from 1 ms

3a - Turn-on of the power amplifier with mute on, diagnostic defeat.

<table>
<thead>
<tr>
<th>Start</th>
<th>Address byte with D0 = 0</th>
<th>ACK</th>
<th>IB1</th>
<th>ACK</th>
<th>IB2</th>
<th>ACK</th>
<th>STOP</th>
</tr>
</thead>
</table>

3b - Turn-off of the power amplifier

<table>
<thead>
<tr>
<th>Start</th>
<th>Address byte with D0 = 0</th>
<th>ACK</th>
<th>IB1</th>
<th>ACK</th>
<th>IB2</th>
<th>ACK</th>
<th>STOP</th>
</tr>
</thead>
</table>

4 - Offset detection procedure enable

<table>
<thead>
<tr>
<th>Start</th>
<th>Address byte with D0 = 0</th>
<th>ACK</th>
<th>IB1</th>
<th>ACK</th>
<th>IB2</th>
<th>ACK</th>
<th>STOP</th>
</tr>
</thead>
</table>

5 - Offset detection procedure stop and reading operation (the results are valid only for the offset detection bits (D2 of the bytes DB1, DB2).

<table>
<thead>
<tr>
<th>Start</th>
<th>Address byte with D0 = 1</th>
<th>ACK</th>
<th>DB1</th>
<th>ACK</th>
<th>DB2</th>
<th>ACK</th>
<th>STOP</th>
</tr>
</thead>
</table>

- The purpose of this test is to check if a D.C. offset (2 V typ.) is present on the outputs, produced by input capacitor with anomalous leakage current or humidity between pins.
- The delay from 4 to 5 can be selected by software, starting from 1 ms.
# Package information

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK® packages, depending on their level of environmental compliance. ECOPACK® specifications, grade definitions and product status are available at: [www.st.com](http://www.st.com).

ECOPACK® is an ST trademark.

## 11.1 PowerSO-36 (slug up) package mechanical data

**Figure 40. PowerSO-36 (slug up) package mechanical drawing**

<table>
<thead>
<tr>
<th>Symbol</th>
<th>Millimeters</th>
<th>Inches</th>
</tr>
</thead>
<tbody>
<tr>
<td>A</td>
<td>3.27</td>
<td>-</td>
</tr>
<tr>
<td>A2</td>
<td>3.1</td>
<td>-</td>
</tr>
<tr>
<td>A4</td>
<td>0.8</td>
<td>-</td>
</tr>
</tbody>
</table>

Table 11. PowerSO-36 (slug up) package mechanical data
### Table 11. PowerSO-36 (slug up) package mechanical data (continued)

<table>
<thead>
<tr>
<th>Symbol</th>
<th>Millimeters</th>
<th>Inches</th>
</tr>
</thead>
<tbody>
<tr>
<td>A5</td>
<td>-</td>
<td>0.2</td>
</tr>
<tr>
<td>a1</td>
<td>0.03</td>
<td>-</td>
</tr>
<tr>
<td>b</td>
<td>0.22</td>
<td>-</td>
</tr>
<tr>
<td>c</td>
<td>0.23</td>
<td>-</td>
</tr>
<tr>
<td>D(^{(1)})</td>
<td>15.8</td>
<td>-</td>
</tr>
<tr>
<td>D1</td>
<td>9.4</td>
<td>-</td>
</tr>
<tr>
<td>D2</td>
<td>-</td>
<td>1.0</td>
</tr>
<tr>
<td>E</td>
<td>13.9</td>
<td>-</td>
</tr>
<tr>
<td>E1(^{(1)})</td>
<td>10.9</td>
<td>-</td>
</tr>
<tr>
<td>E2</td>
<td>-</td>
<td>-</td>
</tr>
<tr>
<td>E3</td>
<td>5.8</td>
<td>-</td>
</tr>
<tr>
<td>E4</td>
<td>2.9</td>
<td>-</td>
</tr>
<tr>
<td>e</td>
<td>-</td>
<td>0.65</td>
</tr>
<tr>
<td>e3</td>
<td>-</td>
<td>11.05</td>
</tr>
<tr>
<td>G</td>
<td>0</td>
<td>-</td>
</tr>
<tr>
<td>H</td>
<td>15.5</td>
<td>-</td>
</tr>
<tr>
<td>h</td>
<td>-</td>
<td>-</td>
</tr>
<tr>
<td>L</td>
<td>0.8</td>
<td>-</td>
</tr>
<tr>
<td>N</td>
<td>-</td>
<td>-</td>
</tr>
<tr>
<td>s</td>
<td>-</td>
<td>-</td>
</tr>
</tbody>
</table>

1. "D" and 'E1' do not include mold flash or protusions.
Mold flash or protusions shall not exceed 0.15mm (0.006").
11.2 **Flexiwatt 27 (vertical) package mechanical data**

Figure 41. Flexiwatt 27 (vertical) package mechanical drawing

Table 12. Flexiwatt 27 (vertical) package mechanical data

<table>
<thead>
<tr>
<th>Symbol</th>
<th>Millimeters</th>
<th>Inches</th>
</tr>
</thead>
<tbody>
<tr>
<td>A</td>
<td>4.45</td>
<td>4.50</td>
</tr>
<tr>
<td>B</td>
<td>1.80</td>
<td>1.90</td>
</tr>
<tr>
<td>C</td>
<td>-</td>
<td>1.40</td>
</tr>
<tr>
<td>D</td>
<td>0.75</td>
<td>0.90</td>
</tr>
<tr>
<td>E</td>
<td>0.37</td>
<td>0.39</td>
</tr>
<tr>
<td>F(1)</td>
<td>-</td>
<td>-</td>
</tr>
<tr>
<td>G</td>
<td>0.80</td>
<td>1.00</td>
</tr>
<tr>
<td>G1</td>
<td>25.75</td>
<td>26.00</td>
</tr>
<tr>
<td>H(2)</td>
<td>28.90</td>
<td>29.23</td>
</tr>
<tr>
<td>H1</td>
<td>-</td>
<td>17.00</td>
</tr>
<tr>
<td>H2</td>
<td>-</td>
<td>12.80</td>
</tr>
<tr>
<td>H3</td>
<td>-</td>
<td>0.80</td>
</tr>
</tbody>
</table>
# Table 12. Flexiwatt 27 (vertical) package mechanical data (continued)

<table>
<thead>
<tr>
<th>Symbol</th>
<th>Millimeters</th>
<th>Inches</th>
</tr>
</thead>
<tbody>
<tr>
<td>L  (2)</td>
<td>22.07</td>
<td>22.47</td>
</tr>
<tr>
<td>L1</td>
<td>18.57</td>
<td>18.97</td>
</tr>
<tr>
<td>L2  (2)</td>
<td>15.50</td>
<td>15.70</td>
</tr>
<tr>
<td>L3</td>
<td>7.70</td>
<td>7.85</td>
</tr>
<tr>
<td>L4</td>
<td>-</td>
<td>5</td>
</tr>
<tr>
<td>L5</td>
<td>3.35</td>
<td>3.5</td>
</tr>
<tr>
<td>M</td>
<td>3.70</td>
<td>4.00</td>
</tr>
<tr>
<td>M1</td>
<td>3.60</td>
<td>4.00</td>
</tr>
<tr>
<td>N</td>
<td>-</td>
<td>2.20</td>
</tr>
<tr>
<td>O</td>
<td>-</td>
<td>2</td>
</tr>
<tr>
<td>R</td>
<td>-</td>
<td>1.70</td>
</tr>
<tr>
<td>R1</td>
<td>-</td>
<td>0.5</td>
</tr>
<tr>
<td>R2</td>
<td>-</td>
<td>0.3</td>
</tr>
<tr>
<td>R3</td>
<td>-</td>
<td>1.25</td>
</tr>
<tr>
<td>R4</td>
<td>-</td>
<td>0.50</td>
</tr>
<tr>
<td>V</td>
<td>-</td>
<td>5°</td>
</tr>
<tr>
<td>V1</td>
<td>-</td>
<td>3°</td>
</tr>
<tr>
<td>V2</td>
<td>-</td>
<td>20°</td>
</tr>
<tr>
<td>V3</td>
<td>-</td>
<td>45°</td>
</tr>
</tbody>
</table>

1. dam-bar protusion not included.
2. molding protusion included.
11.3 Flexiwatt 27 (horizontal) package mechanical data

Figure 42. Flexiwatt 27 (horizontal) package mechanical drawing

Table 13. Flexiwatt 27 (horizontal) package mechanical data

<table>
<thead>
<tr>
<th>Symbol</th>
<th>Millimeters</th>
<th></th>
<th></th>
<th></th>
<th>Inches</th>
</tr>
</thead>
<tbody>
<tr>
<td>A</td>
<td>4.45</td>
<td>4.50</td>
<td>4.65</td>
<td>0.175</td>
<td>0.177</td>
</tr>
<tr>
<td>B</td>
<td>1.80</td>
<td>1.90</td>
<td>2.00</td>
<td>0.070</td>
<td>0.074</td>
</tr>
<tr>
<td>C</td>
<td>-</td>
<td>1.40</td>
<td>-</td>
<td>-</td>
<td>0.055</td>
</tr>
<tr>
<td>D</td>
<td>-</td>
<td>2.00</td>
<td>-</td>
<td>-</td>
<td>0.079</td>
</tr>
<tr>
<td>E</td>
<td>0.37</td>
<td>0.39</td>
<td>0.42</td>
<td>0.014</td>
<td>0.015</td>
</tr>
<tr>
<td>F(1)</td>
<td>-</td>
<td>-</td>
<td>0.57</td>
<td>-</td>
<td>-</td>
</tr>
<tr>
<td>G</td>
<td>0.75</td>
<td>1.00</td>
<td>1.25</td>
<td>0.0295</td>
<td>0.040</td>
</tr>
<tr>
<td>G1</td>
<td>25.70</td>
<td>26.00</td>
<td>26.30</td>
<td>1.0118</td>
<td>1.023</td>
</tr>
</tbody>
</table>
Table 13. Flexiwatt 27 (horizontal) package mechanical data (continued)

<table>
<thead>
<tr>
<th>Symbol</th>
<th>Millimeters</th>
<th></th>
<th>Inches</th>
<th></th>
</tr>
</thead>
<tbody>
<tr>
<td>H (2)</td>
<td>28.90</td>
<td>29.23</td>
<td>29.30</td>
<td>1.139</td>
</tr>
<tr>
<td>H1</td>
<td>-</td>
<td>17.00</td>
<td>-</td>
<td>-</td>
</tr>
<tr>
<td>H2</td>
<td>-</td>
<td>12.80</td>
<td>-</td>
<td>-</td>
</tr>
<tr>
<td>H3</td>
<td>-</td>
<td>0.80</td>
<td>-</td>
<td>-</td>
</tr>
<tr>
<td>L (2)</td>
<td>21.64</td>
<td>22.04</td>
<td>22.44</td>
<td>0.852</td>
</tr>
<tr>
<td>L1</td>
<td>10.15</td>
<td>10.50</td>
<td>10.85</td>
<td>0.40</td>
</tr>
<tr>
<td>L2 (2)</td>
<td>15.50</td>
<td>15.70</td>
<td>15.90</td>
<td>0.610</td>
</tr>
<tr>
<td>L3</td>
<td>7.70</td>
<td>7.85</td>
<td>7.95</td>
<td>0.303</td>
</tr>
<tr>
<td>L4</td>
<td>-</td>
<td>5</td>
<td>-</td>
<td>-</td>
</tr>
<tr>
<td>L5</td>
<td>5.15</td>
<td>5.45</td>
<td>5.85</td>
<td>0.203</td>
</tr>
<tr>
<td>M</td>
<td>2.75</td>
<td>3.00</td>
<td>3.50</td>
<td>0.108</td>
</tr>
<tr>
<td>M1</td>
<td>-</td>
<td>4.73</td>
<td>-</td>
<td>-</td>
</tr>
<tr>
<td>M2</td>
<td>-</td>
<td>5.61</td>
<td>-</td>
<td>-</td>
</tr>
<tr>
<td>N</td>
<td>-</td>
<td>2.20</td>
<td>-</td>
<td>-</td>
</tr>
<tr>
<td>P</td>
<td>3.20</td>
<td>3.50</td>
<td>3.80</td>
<td>0.126</td>
</tr>
<tr>
<td>R</td>
<td>-</td>
<td>1.70</td>
<td>-</td>
<td>-</td>
</tr>
<tr>
<td>R1</td>
<td>-</td>
<td>0.5</td>
<td>-</td>
<td>-</td>
</tr>
<tr>
<td>R2</td>
<td>-</td>
<td>0.3</td>
<td>-</td>
<td>-</td>
</tr>
<tr>
<td>R3</td>
<td>-</td>
<td>1.25</td>
<td>-</td>
<td>-</td>
</tr>
<tr>
<td>R4</td>
<td>-</td>
<td>0.50</td>
<td>-</td>
<td>-</td>
</tr>
<tr>
<td>V</td>
<td>-</td>
<td>5°</td>
<td>-</td>
<td>-</td>
</tr>
<tr>
<td>V1</td>
<td>-</td>
<td>3°</td>
<td>-</td>
<td>-</td>
</tr>
<tr>
<td>V2</td>
<td>-</td>
<td>20°</td>
<td>-</td>
<td>-</td>
</tr>
<tr>
<td>V3</td>
<td>-</td>
<td>45°</td>
<td>-</td>
<td>-</td>
</tr>
</tbody>
</table>

1. dam-bar protusion not included.
2. molding protusion included.
11.4 Flexiwatt 27 (SMD) package mechanical data

Table 14. Flexiwatt 27 (SMD) package mechanical data

<table>
<thead>
<tr>
<th>Symbol</th>
<th>Millimeters</th>
<th>Inches</th>
</tr>
</thead>
<tbody>
<tr>
<td>A</td>
<td>4.45</td>
<td>4.50</td>
</tr>
<tr>
<td>B</td>
<td>2.12</td>
<td>2.22</td>
</tr>
<tr>
<td>C</td>
<td>-</td>
<td>1.40</td>
</tr>
<tr>
<td>D</td>
<td>-</td>
<td>2.00</td>
</tr>
<tr>
<td>E</td>
<td>0.36</td>
<td>0.40</td>
</tr>
<tr>
<td>F(1)</td>
<td>0.47</td>
<td>0.51</td>
</tr>
<tr>
<td>G(2)</td>
<td>0.75</td>
<td>1.00</td>
</tr>
<tr>
<td>G1</td>
<td>25.70</td>
<td>26.00</td>
</tr>
<tr>
<td>G2(2)</td>
<td>1.75</td>
<td>2.00</td>
</tr>
</tbody>
</table>
Table 14. Flexiwatt 27 (SMD) package mechanical data (continued)

<table>
<thead>
<tr>
<th>Symbol</th>
<th>Millimeters</th>
<th>Inches</th>
</tr>
</thead>
<tbody>
<tr>
<td>(H^{(1)})</td>
<td>28.85</td>
<td>29.23</td>
</tr>
<tr>
<td>H1</td>
<td>-</td>
<td>17.00</td>
</tr>
<tr>
<td>H2</td>
<td>-</td>
<td>12.80</td>
</tr>
<tr>
<td>H3</td>
<td>-</td>
<td>0.80</td>
</tr>
<tr>
<td>(L^{(1)})</td>
<td>15.50</td>
<td>15.70</td>
</tr>
<tr>
<td>L1</td>
<td>7.70</td>
<td>7.85</td>
</tr>
<tr>
<td>L2</td>
<td>14.00</td>
<td>14.20</td>
</tr>
<tr>
<td>L3</td>
<td>11.80</td>
<td>12.00</td>
</tr>
<tr>
<td>L4</td>
<td>1.30</td>
<td>1.48</td>
</tr>
<tr>
<td>L5</td>
<td>2.42</td>
<td>2.50</td>
</tr>
<tr>
<td>L6</td>
<td>0.42</td>
<td>0.50</td>
</tr>
<tr>
<td>M</td>
<td>-</td>
<td>1.50</td>
</tr>
<tr>
<td>N</td>
<td>-</td>
<td>2.20</td>
</tr>
<tr>
<td>N1</td>
<td>1.30</td>
<td>1.48</td>
</tr>
<tr>
<td>N2(^{(2)})</td>
<td>2.73(^{(2)})</td>
<td>2.83</td>
</tr>
<tr>
<td>P(^{(2)})</td>
<td>4.73</td>
<td>4.83</td>
</tr>
<tr>
<td>R</td>
<td>-</td>
<td>1.70</td>
</tr>
<tr>
<td>R1</td>
<td>-</td>
<td>0.30</td>
</tr>
<tr>
<td>R2</td>
<td>0.35</td>
<td>0.40</td>
</tr>
<tr>
<td>R3</td>
<td>0.35</td>
<td>0.40</td>
</tr>
<tr>
<td>R4</td>
<td>-</td>
<td>0.50</td>
</tr>
<tr>
<td>T(^{(2)})</td>
<td>-0.08</td>
<td>-</td>
</tr>
<tr>
<td>aaa(^{(2)})</td>
<td>-</td>
<td>0.1</td>
</tr>
<tr>
<td>V</td>
<td>-</td>
<td>45°</td>
</tr>
</tbody>
</table>

1. Dimension “F” doesn’t include dam-bar protrusion.
2. Golden parameters.
### 12 Revision history

<table>
<thead>
<tr>
<th>Date</th>
<th>Revision</th>
<th>Changes</th>
</tr>
</thead>
<tbody>
<tr>
<td>14-Oct-2013</td>
<td>1</td>
<td>Initial release.</td>
</tr>
<tr>
<td>10-Feb-2014</td>
<td>2</td>
<td>Updated Table 4: Electrical characteristics and Section 9.5: I2C programming/reading sequences.</td>
</tr>
<tr>
<td>03-Mar-2014</td>
<td>3</td>
<td>Updated Table 4: Electrical characteristics ($\Delta V_{OITU}$ parameter on page 10).</td>
</tr>
<tr>
<td>22-Sep-2014</td>
<td>4</td>
<td>Updated Section 9.5: I2C programming/reading sequences on page 29.</td>
</tr>
<tr>
<td>13-Jan-2015</td>
<td>5</td>
<td>Updated: Table 9: DB1 on page 31 (D7); Section 11: Package information.</td>
</tr>
</tbody>
</table>
IMPORTANT NOTICE – PLEASE READ CAREFULLY

STMicroelectronics NV and its subsidiaries (“ST”) reserve the right to make changes, corrections, enhancements, modifications, and improvements to ST products and/or to this document at any time without notice. Purchasers should obtain the latest relevant information on ST products before placing orders. ST products are sold pursuant to ST's terms and conditions of sale in place at the time of order acknowledgement.

Purchasers are solely responsible for the choice, selection, and use of ST products and ST assumes no liability for application assistance or the design of Purchasers’ products.

No license, express or implied, to any intellectual property right is granted by ST herein.

Resale of ST products with provisions different from the information set forth herein shall void any warranty granted by ST for such product.

ST and the ST logo are trademarks of ST. All other product or service names are the property of their respective owners.

Information in this document supersedes and replaces information previously supplied in any prior versions of this document.

© 2015 STMicroelectronics – All rights reserved
Mouser Electronics

Authorized Distributor

Click to View Pricing, Inventory, Delivery & Lifecycle Information:

**STMicroelectronics:**

TDA7577BLVPDTR  TDA7577BLV  TDA7577BLVPD